



JLZ7387

60V / 150mA Low Drop-out Linear Regulator

Description

JLZ7387 is a high-performance low drop-out linear regulator with wide input voltage range at 5 ~ 60V and output current up to 150mA. The drop-out voltage is as low as 0.65V at I_{OUT} = 100mA. The quiescent current is exceptionally small at 2.1µA. The device responds swiftly to transients over the output load and the line input.

PSRR performance of 70dB @ 1kHz makes the device a good fit for applications (e.g. 4G, WiFi module, smart wearables) in which clean supply line is often deemed critical. Armed with comprehensive protection features (thermal shut-down, short-circuit handling, current limiting) and precision band-gap reference, the device delivers accurate (± 2%) output voltages at 3.3V, 5.0V respectively.

JLZ7387 is manufactured [halogen, lead, antimony] free and RoHS compliant. Packages offered are: SOT-23-3L, SOT-89-3L.

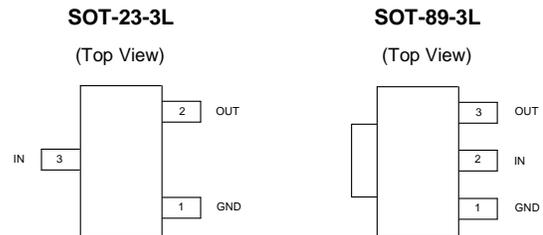
Features and Benefits

- Wide range of input voltages at 5 ~ 60V with maximum output current at 150mA
- Low quiescent current at 2.1µA
- Low drop-out voltage of 650mV at 100mA
- High noise rejection with PSRR of 70dB typically at 1kHz
- Fixed output voltages with high accuracy (± 2%) at 3.3V, 5.0V
- Excellent load regulation at 0.1 mV/mA
- Excellent line regulation at 0.1 mV/V
- Built-in fault protection to minimize the effect of system hazards like short-circuit, over-current, and over-temperature
- Lead-free package assembled with 'green' molding compound

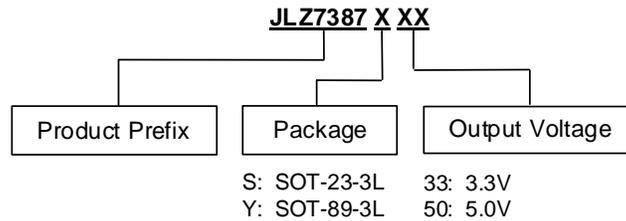
Applications

- Voltage regulation for wireless access modules
- Mainboards in Industrial robotics, remote networked clients, A/EIoT smart terminals
- Motherboards in telecommunication base station, power boards in commercial transportation and after-market add-ons

Pin Assignment

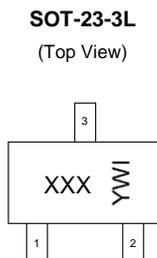


Ordering Information

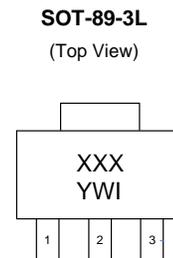


Product Name	Package	Marking	MSL	T _J (°C)	Media	Quantity (pcs)
JLZ7387S-33	SOT-23-3L	J833	3	-40 ~ 125	7" T&R	3,000
JLZ7387S-50		J850				
JLZ7387Y-33	SOT-89-3L	J833	3	-40 ~ 125	7" T&R	1,000
JLZ7387Y-50		J850				

Marking Information



First Horizontal Line: Marking (see *Ordering Information*)
 Second Line (Horizontal or Vertical): Date Code
 Y: Year of Molding
 W: Work-week of Molding
 I: Internal Code



Typical Application Circuit

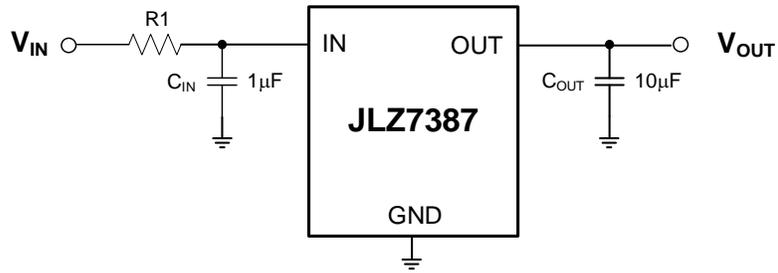


Fig. 1: Application Circuit

Functional Blocks

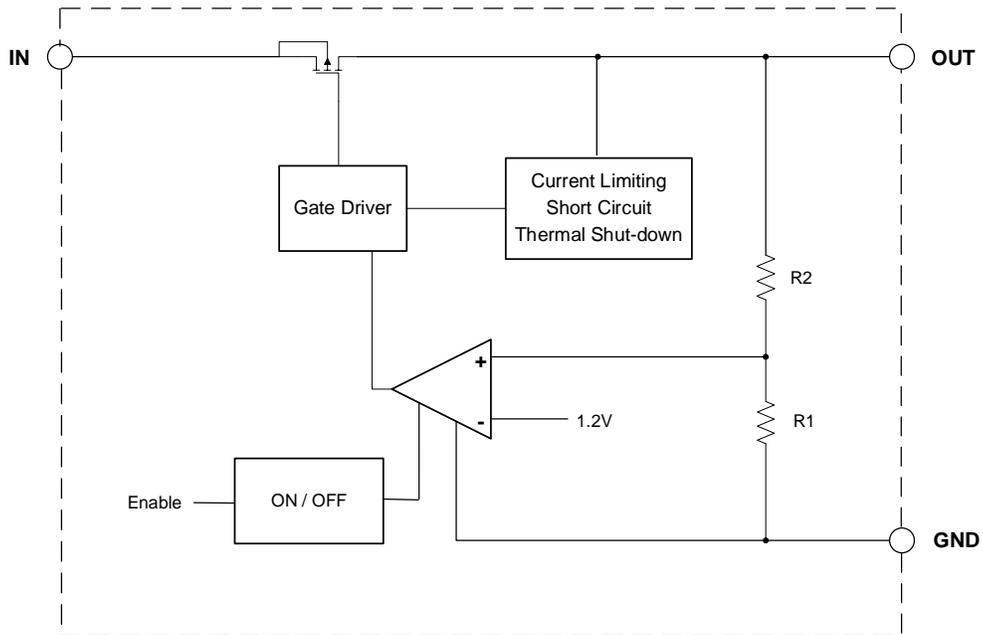


Fig. 2: Diagram of Internal Functional Blocks

**Absolute Maximum Ratings** *1 (All measurements were made at $T_A = 25^\circ\text{C}$ unless otherwise stated)

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{OPER}	Operating Voltage Range	IN to GND	-0.3	80.0	V
		OUT to GND	-0.3	12.0	
		IN to OUT	-0.3	75.0	
I_{OUT}	Output Current	Internally Limited	-	350	mA
T_J	Operating Junction Temperature	-	-	150	$^\circ\text{C}$
T_A	Operating Ambient Temperature	-	-40	125	$^\circ\text{C}$
T_{STG}	Storage Temperature	-	-40	150	
P_D	Power Dissipation	SOT-23-3L	-	600	mW
		SOT-89-3L	-	900	
V_{ESD}	Human Body Model (HBM)	-	-	4	kV
	Charged Device Model (CDM)	-	-	200	V

Notes 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. While these are stress ratings only, functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" are not implied. Exposure to "Absolute Maximum Ratings" over extended periods may adversely affect the device reliability.

Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{IN}	Input Voltage	-	5	60	V
T_J	Operating Junction Temperature	-	-40	125	$^\circ\text{C}$

Electrical Characteristics

Test Conditions ($V_{\text{IN}} = [V_{\text{SET}} + 1.0\text{V}]$ where $V_{\text{SET}} = V_{\text{OUT}} @ 3.3 / 5.0\text{V}$; $C_{\text{IN}} = 1.0\mu\text{F}$ (ceramic); $C_{\text{OUT}} = 10.0\mu\text{F}$ (ceramic); $T_A = 25^\circ\text{C}$) are applicable to the following measurements unless otherwise stated.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{IN}	Operating Input Voltage	-	5	-	60.0	V
V_{OUT}	Output Voltage	$V_{\text{IN}} = 12\text{V}$, $I_{\text{OUT}} = 10\text{mA}$	$V_{\text{SET}} * 0.98$	V_{SET}	$V_{\text{SET}} * 1.02$	V
$I_{\text{OUT-Max}}$	Output Current	-	-	150	-	mA
I_{Q}	Quiescent Current	$V_{\text{IN}} = 12\text{V}$; no load	-	2.1	-	μA
V_{DROP}	Drop-out Voltage ($V_{\text{OUT}} = 3.3\text{V}$)	$I_{\text{OUT}} = 10\text{mA}$; $V_{\text{IN}} = V_{\text{SET}} - 0.1\text{V}$	-	65	-	mV
		$I_{\text{OUT}} = 100\text{mA}$; $V_{\text{IN}} = V_{\text{SET}} - 0.1\text{V}$	-	650	-	mV
	Drop-out Voltage ($V_{\text{OUT}} = 5.0\text{V}$)	$I_{\text{OUT}} = 10\text{mA}$; $V_{\text{IN}} = V_{\text{SET}} - 0.1\text{V}$	-	55	-	mV
		$I_{\text{OUT}} = 100\text{mA}$; $V_{\text{IN}} = V_{\text{SET}} - 0.1\text{V}$	-	550	-	mV
Reg_{Load}	Load Regulation, $\Delta V_{\text{OUT}} / \Delta I_{\text{OUT}}$	$V_{\text{IN}} = 7\text{V}$; $1\text{mA} \leq I_{\text{OUT}} \leq 100\text{mA}$	-	0.1	-	mV/mA
Reg_{Line}	Line Regulation, $\Delta V_{\text{OUT}} / \Delta V_{\text{IN}}$	$I_{\text{OUT}} = 1\text{mA}$; $[V_{\text{SET}} + 0.5\text{V}] \leq V_{\text{IN}} \leq 60\text{V}$	-	0.1	-	mV/V
I_{LIMIT}	Current Limit Threshold	$V_{\text{IN}} = V_{\text{SET}} + 2\text{V}$	-	250	-	mA
PSRR	Power Supply Rejection Ratio	$V_{\text{IN}} = 10\text{V}$; $I_{\text{OUT}} = 10\text{mA}$; $f = 1\text{kHz}$ $V_{\text{OUT}} = 3.3\text{V}$	-	70	-	dB
T_{TSD}	Thermal Shut-down Threshold	Temperature rising	-	150	-	$^\circ\text{C}$
		Temperature falling	-	115	-	$^\circ\text{C}$



Thermal Properties

Test Conditions: Device mounted on FR-4 substrate, 2-layer PCB, 2oz copper, with minimum recommended cooling pad to dissipate heat

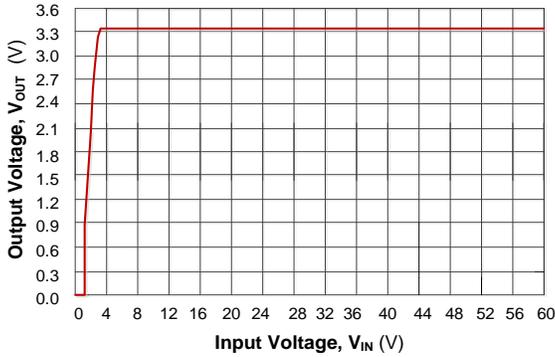
Symbol	Parameter	Conditions	Rating	Unit
R _{θJA}	Thermal Resistance (junction-to-ambient)	SOT-23-3L	200	°C/W
		SOT-89-3L	130	



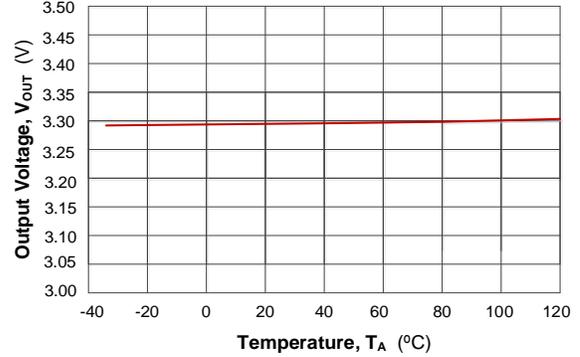
Typical Performance Characteristics

Unless otherwise stated, the following test conditions apply: $V_{IN} = 12V$; $V_{OUT} = 3.3V$; $I_{OUT} = 1mA$; $C_{OUT} = 10\mu F$; $T_A = 25^\circ C$

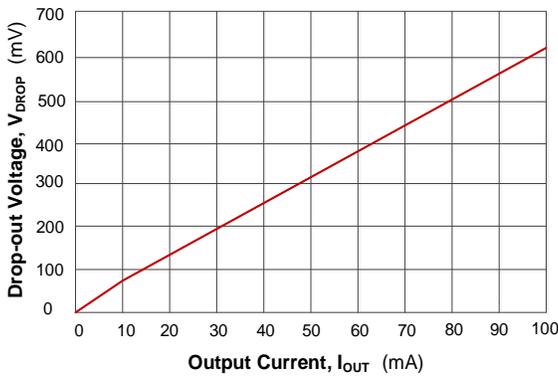
Graph 1: Output Voltage vs. Input Voltage



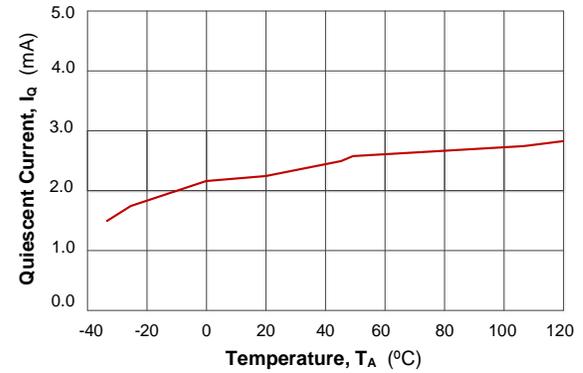
Graph 2: Output Voltage vs. Temperature



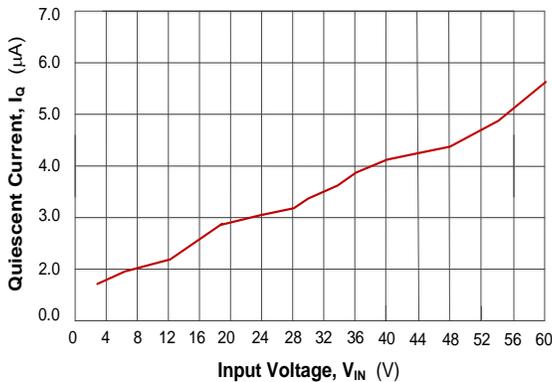
Graph 3: Drop-out Voltage vs. Output Current



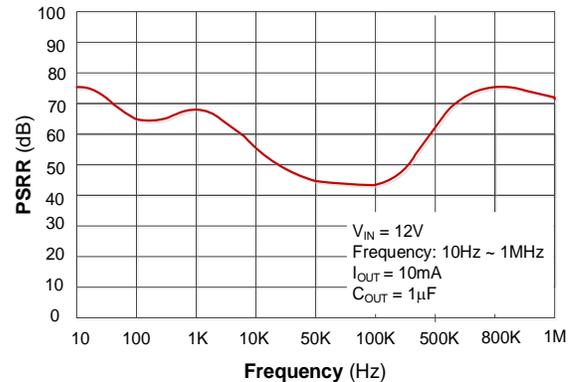
Graph 4: Quiescent Current vs. Temperature



Graph 5: Quiescent Current vs. Input Voltage



Graph 6: Power Supply Rejection Ratio vs. Frequency

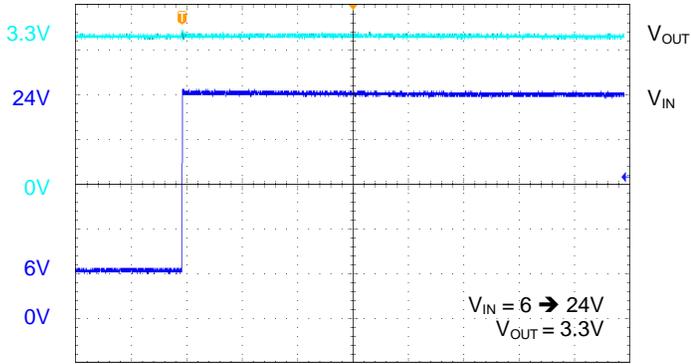




Typical Performance Characteristics (Continued)

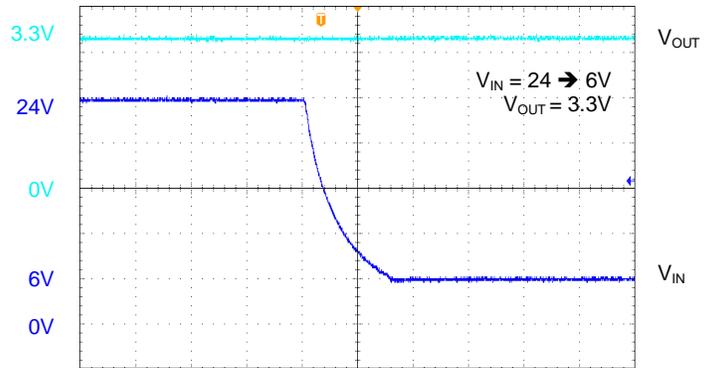
Unless otherwise stated, the following test conditions apply: $V_{IN} = 12V$; $V_{OUT} = 3.3V$; $I_{OUT} = 1mA$; $C_{OUT} = 10\mu F$; $T_A = 25^\circ C$

Graph 7: Response to Line Transients ↑



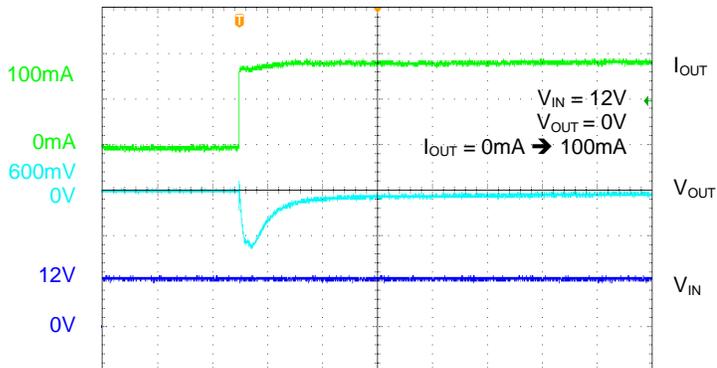
Time @ 4μs/div.

Graph 8: Response to Line Transients ↓



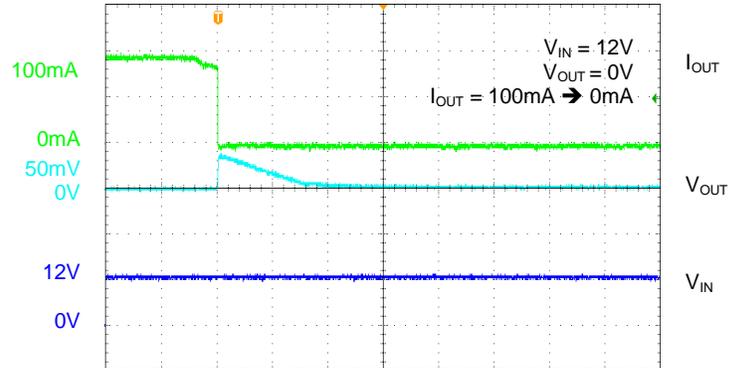
Time @ 4μs/div.

Graph 9: Response to Load Transients ↑



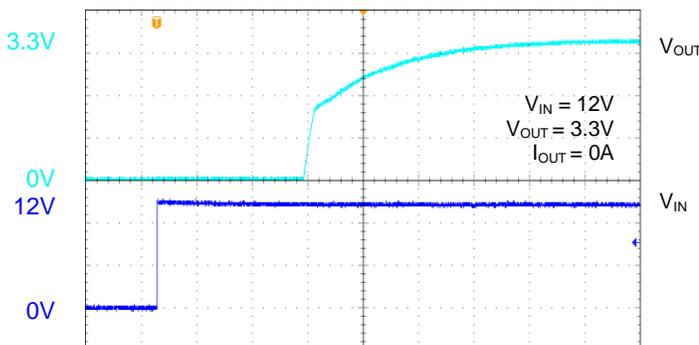
Time @ 200μs/div.

Graph 10: Response to Load Transients ↓



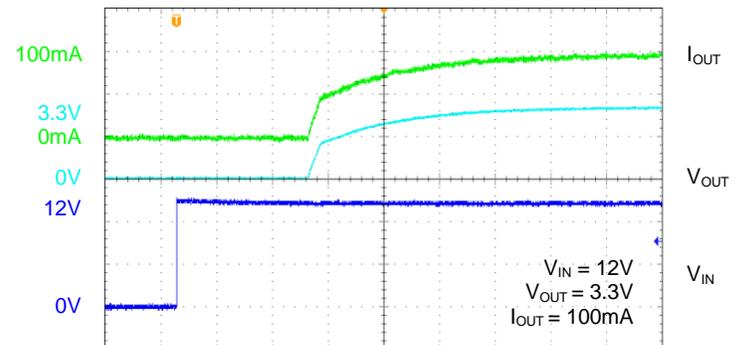
Time @ 200μs/div.

Graph 12: Start-up with no Load at OUT Pin



Time @ 200μs/div.

Graph 13: Start-up with I_OUT = 100mA at OUT Pin



Time @ 200μs/div.



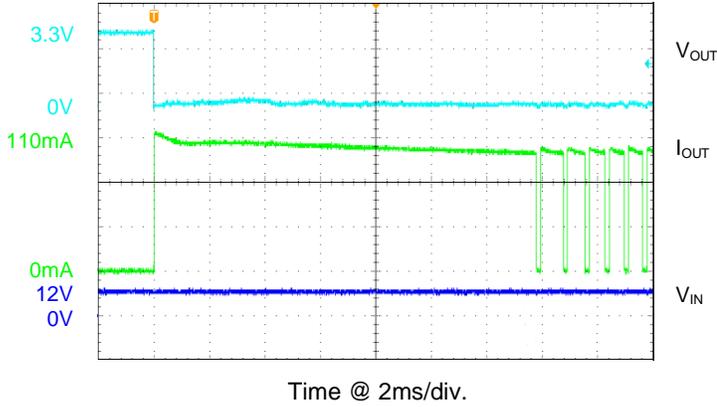
JLZ7387

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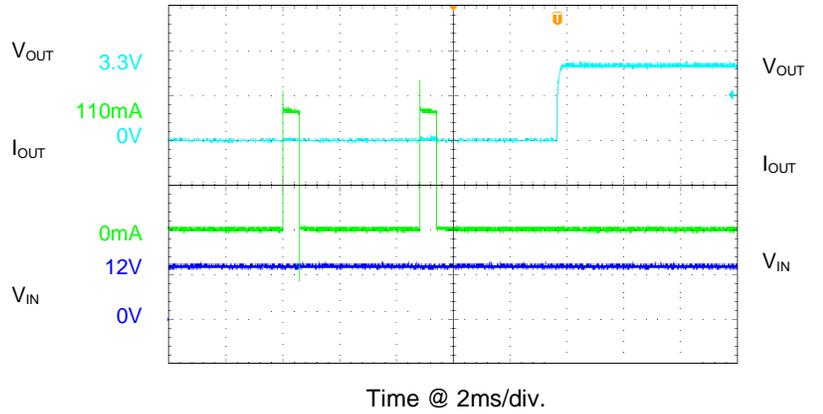
Typical Performance Characteristics (Continued)

Unless otherwise stated, the following test conditions apply: $V_{IN} = 12V$; $V_{OUT} = 3.3V$; $I_{OUT} = 1mA$; $C_{OUT} = 10\mu F$; $T_A = 25^\circ C$

Graph 14: Short-circuit Protection Assert



Graph 15: Short-circuit Protection Dis-asserted





Detailed Description of Device Operation

Overview

JLZ7387 is a power-efficient linear regulator with ultra-wide input voltage range from 5V to 60V and output current at up to 150mA. Three output voltage levels are offered: 3.3V, 5.0V

The device offers low drop-out voltage at down to 55mV typically. The quiescent current is designed to be at a very low 2.1μA typically. The PSRR performance is an outstanding 70dB at frequency of 1kHz while both load and line regulation are highly accurate at ± 2% typically. In order to protect the device from operation hazards, full suite of fault detection & handling is embedded.

Input and Output

In order to de-couple the noise and glitch present on the power line at the input of JLZ7387 and the circuit board on which the device is populated, input capacitor (C_{IN} in Fig. 1) of ceramic type with value of 1μF shall be populated as close as possible to the IN pin. Wide copper trace is required between the IN and the GND pins. When $V_{IN} \geq 18V$, a resistor (R1) shall be added to the IN pin (c.r. Fig. 1) to protect the device from damage by in-rush. While the value of R_{IN} is dependent on the actual application in which the device is deployed, it must be larger than 1Ω.

In order to ensure loop stability and to improve the response of the device to load & line transients, output capacitor (C_{OUT} in Fig. 1) of ceramic type with value of at least 10μF is recommended to be placed as close as possible to the OUT pin. The effective series resistance (ESR) of the output capacitor shall be kept within the range of 1mΩ ~ 5Ω.

In order to minimize the temperature dependence of the application circuit, either X6S or X7R type is recommended for both the input and output capacitors.

Current Protection

In the design of JLZ7387, fault detection & handling are in place to ensure device reliability and operation safety. These are the current limiting and short-circuit handling. Whenever one or multiple of the following conditions occur, the output current shall be clamped to a preset level (~ 100mA) to prevent damage to the load and the device from over-heat.

- 1) Output current at the OUT pin is higher than the current limit threshold (I_{LIMIT})
- 2) OUT pin is shorted to the GND pin

Thermal Protection & Power Dissipation

When the junction temperature (T_J) of the silicon die assembled inside the device goes up beyond the normality, due either to excessive loading or short-circuit at the OUT pin, the built-in thermal shut-down protection shall be triggered. The on-die power MOSFET shall be turned OFF to prevent the device from electrical overload. Once the abnormality disappears or the junction temperature of the die comes down, the device shall resume its standard operation.

As the device operates in its typical manner, the junction temperature of the internal die goes up inevitably. Ability of the package assembly (bonding wires, lead frame, die-attach material, epoxy, etc.) to dissipate the heat generated within shall determine the overall power dissipation, P_D :

$$P_D = (V_{IN} - V_{OUT}) * I_{OUT}$$

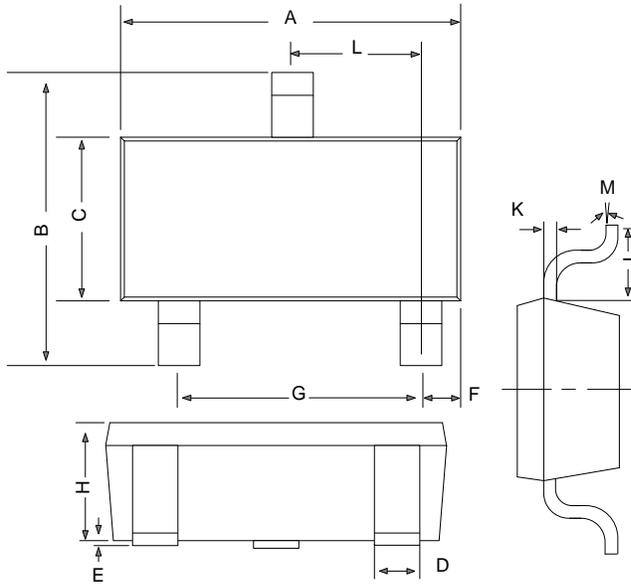
In reference to the junction-to-ambient thermal resistance ($R_{\theta JA_PCB}$) of the circuit board on which the device is populated, the junction temperature of the die inside the device's package can be estimated using the following equation:

$$T_J = T_A + P_D * R_{\theta JA_PCB}$$

The value of $R_{\theta JA_PCB}$ is determined, though not exclusively, by the following factors: power dissipation of the device, air flow and ambient temperature of the operating environment, PCB area, size & thickness of the copper thermal pad or the external heat sink (if any) attached, closeness of the components populated around the device, etc.

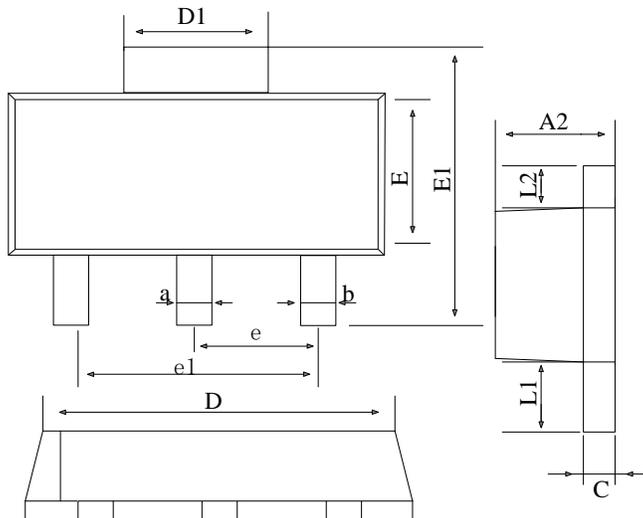
Package Outline (All measurements in mm)

Package Type: SOT-23-3L (J1)



SOT-23-3L (J1)		
Dimension	Min.	Max.
A	2.82	2.92
B	2.65	2.95
C	1.56	1.60
Dimension	0.35	0.55
E	0.00	0.10
F	0.45	0.55
G	1.90 RFF.	
H	1.00	1.30
K	0.10	0.20
J	0.40	-
L	0.85	1.15
M	0°	10°
All measurements in "mm"		

Package Type: SOT-89-3L (J1)



SOT-89-3L (J1)		
Dimension	Min.	Max.
A2	1.40	1.60
a	0.45	0.55
b	0.38	0.48
c	0.36	0.46
D	4.40	4.60
D1	1.60	1.80
E	2.40	2.60
E1	4.00	4.30
e	1.00	2.00
e1	2.95	3.05
L1	0.80	1.00
L2	0.65	0.75
All measurements in "mm"		



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60V / 150mA Low Drop-out Linear Regulator

Disclaimer

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